



Material Content Data Sheet



Sales Product Name		TLE8888-2QK		Issued		1. August 2018			
MA#		MA001998120							
Package		PG-LQFP-100-26		Weight*		700.89 mg			
Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]	
chip	inorganic material	silicon	7440-21-3	52.824	7.54	7.54	75367	75367	
leadframe	inorganic material	phosphorus	7723-14-0	0.054	0.01		77		
		non noble metal	zinc	7440-66-6	0.216	0.03		308	
		non noble metal	iron	7439-89-6	4.316	0.62		6157	
wire	non noble metal	non noble metal	copper	7440-50-8	175.229	25.00	25.66	250008	256550
		non noble metal	copper	7440-50-8	4.222	0.60	0.60	6024	6024
		encapsulation	organic material	carbon black	1333-86-4	2.197	0.31		3134
encapsulation	plastics	epoxy resin	-	59.312	8.46		84623		
		inorganic material	silicondioxide	60676-86-0	377.839	53.92	62.69	539082	626839
		leadfinish	noble metal	palladium	7440-05-3	0.003	0.00		4
noble metal	silver			7440-22-4	0.003	0.00		4	
noble metal	gold			7440-57-5	0.005	0.00		7	
plating	non noble metal	nickel	7440-02-0	4.969	0.71	0.71	7090	7105	
		noble metal	silver	7440-22-4	0.004	0.00		6	
		noble metal	palladium	7440-05-3	0.005	0.00		7	
glue	noble metal	noble metal	gold	7440-57-5	0.008	0.00		11	
		non noble metal	nickel	7440-02-0	7.594	1.08	1.08	10835	10859
		plastics	epoxy resin	-	3.024	0.43		4314	
*deviation	< 10%								
Sum in total:						100.00		1000000	

Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
2. Infineon Technologies AG and Infineon Technologies AG suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.
3. All statements are based on our present knowledge, are provided 'as is' and may be subject to change at any time due to technical requirements and development without notification.

This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and does not use any exemption

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